

pdf.dzsc.chitachi

2SD1306

Item	Symbol	Ratings	Unit	
Collector to base voltage	V _{CBO}	30	V	
Collector to emitter voltage	V _{CEO}	15	V	
Emitter to base voltage	V _{EBO}	5	V	
Collector current	Ι _c	0.7	А	
Collector power dissipation	Pc	150	mW	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Absolute Maximum Ratings (Ta = 25° C)

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	_	_	V	$I_{c} = 10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	15	—	—	V	$I_c = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	_	_	V	$I_{\rm E} = 10 \ \mu A, \ I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	_	_	1.0	μΑ	$V_{CB} = 20 \text{ V}, \text{ I}_{E} = 0$
DC current transfer ratio	h _{FE} *1	250		800		$V_{ce} = 1 \text{ V}, I_c = 150 \text{ mA}^{*2}$
Base to emitter voltage	V _{BE}	_		1.0	V	$V_{ce} = 1 \text{ V}, I_c = 150 \text{ mA}^{*2}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	—	—	0.5	V	$I_c = 500 \text{ mA}, I_B = 50 \text{ mA}^{*2}$
Gain bandwidth product	f _T	_	250		MHz	V_{ce} = 1 V, I _c = 150 mA ^{*2}
Notes: 1. The 2SD1306 is grouped by h_{FE} as follows.						
2. Pulse test						
Grade D E		_				
	_					

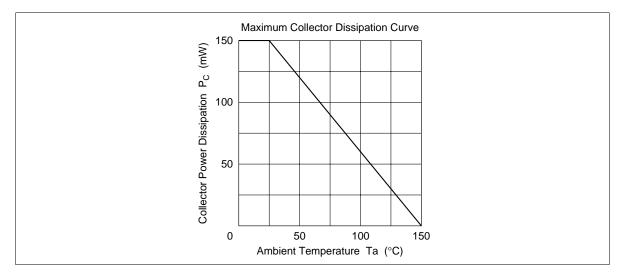
 Mark
 ND
 NE

 h_{FE}
 250 to 500
 400 to 800

See characteristic curves of 2SD1504.

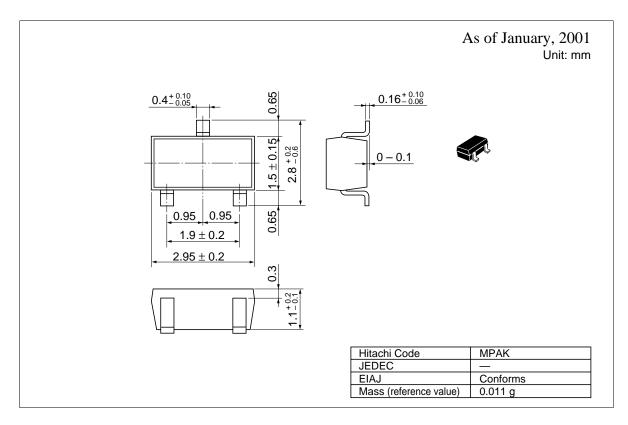
HITACHI

2SD1306



2SD1306

Package Dimensions



Cautions

- 1. Hitachi neither warrants nor grants licenses of any rights of Hitachi's or any third party's patent, copyright, trademark, or other intellectual property rights for information contained in this document. Hitachi bears no responsibility for problems that may arise with third party's rights, including intellectual property rights, in connection with use of the information contained in this document.
- 2. Products and product specifications may be subject to change without notice. Confirm that you have received the latest product standards or specifications before final design, purchase or use.
- 3. Hitachi makes every attempt to ensure that its products are of high quality and reliability. However, contact Hitachi's sales office before using the product in an application that demands especially high quality and reliability or where its failure or malfunction may directly threaten human life or cause risk of bodily injury, such as aerospace, aeronautics, nuclear power, combustion control, transportation, traffic, safety equipment or medical equipment for life support.
- 4. Design your application so that the product is used within the ranges guaranteed by Hitachi particularly for maximum rating, operating supply voltage range, heat radiation characteristics, installation conditions and other characteristics. Hitachi bears no responsibility for failure or damage when used beyond the guaranteed ranges. Even within the guaranteed ranges, consider normally foreseeable failure rates or failure modes in semiconductor devices and employ systemic measures such as failsafes, so that the equipment incorporating Hitachi product does not cause bodily injury, fire or other consequential damage due to operation of the Hitachi product.
- 5. This product is not designed to be radiation resistant.
- 6. No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without written approval from Hitachi.
- 7. Contact Hitachi's sales office for any questions regarding this document or Hitachi semiconductor products.

ITACH

Hitachi. Ltd.

Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL	NorthAmerica
	Europe
	Asia
	Japan

http://semiconductor.hitachi.com/ http://www.hitachi-eu.com/hel/ecg http://sicapac.hitachi-asia.com : http://www.hitachi.co.jp/Sicd/indx.htm

For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, Dornacher Straβe 3

Hitachi Europe GmbH Electronic Components Group
 San Jose, CA 95134
 Donacien Sidge 3

 Tel: <1> (408)
 433-1990

 Germany
 Fax: <1>(408)

 Fax: <1>(408)
 433-0223

 Tel: <49> (89)
 9

 9
 9180-0
 D-85622 Feldkirchen, Munich Fax: <49> (89) 9 29 30 00

> Hitachi Europe Ltd. Electronic Components Group. Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000 Fax: <44> (1628) 585160

Hitachi Asia Ltd. Hitachi Tower 16 Collver Quay #20-00. Singapore 049318 Tel : <65>-538-6533/538-8577 Fax : <65>-538-6933/538-3877 URL : http://www.hitachi.com.sg

Hitachi Asia Ltd. (Taipei Branch Office) 4/F. No. 167. Tun Hwa North Road. Hung-Kuo Building, Taipei (105), Taiwan Tel : <886>-(2)-2718-3666 Fax : <886>-(2)-2718-8180 Telex : 23222 HAS-TP URL : http://www.hitachi.com.tw

Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui Kowloon Hong Kong Tel : <852>-(2)-735-9218 Fax : <852>-(2)-730-0281 URL : http://www.hitachi.com.hk

Copyright © Hitachi, Ltd., 2000. All rights reserved. Printed in Japan.

Colophon 2.0

HITACHI